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Docket No.: 5000-1-339

## **DECLARATION AND POWER OF ATTORNEY**

As a below named inventor (s), I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## SCATTERING MONITOR IN OPTICAL FIBER DRAWING SYSTEMS

was filed on Number	and was amended	oplication Number or PCT In on(if app	plicable).
I hereby state that I have revie	ewed and understand the con-	tents of the above identified s	specification, including the
claims, as amended by any am	nendment referred to above.		
I acknowledge the duty to disc	close information which is m	aterial to patentability as defi	ined in Title 37, Code of
Federal Regulation, § 1.56.			
I hereby claim foreign priority			• • • • • • • • • • • • • • • • • • • •
patent or inventor's certificate	·		• •
inventor's certificate having a	filing date before that of the	application on which priority	is claimed.
Prior Foreign Application(s)		•	
rior rotoign rippitoution(b)			Priority Claimed
2002-44758	Republic of Korea	29/07/2002	Yes No
(Number)	(Country)	(Day/Month/Year Filed	1)
(Number)	(Country)	(Day/Month/Voor Filed	Yes No
(Number)  I hereby claim the benefit und and, insofar as the subject matapplication in the manner prov	tter of each of the claims of the vided by the first paragraph of	his application is not disclose of the Title 35, United States	tes application(s) listed belowed in the prior United States Code, § 112, I acknowledge
I hereby claim the benefit und and, insofar as the subject mat	ler Title 35, United States Co tter of each of the claims of t vided by the first paragraph of on which is material to patent	ode, § 120 of any United Stathis application is not disclose of the Title 35, United States tability as defined in Title 37.	tes application(s) listed belowed in the prior United States Code, § 112, I acknowledge , Code of Federal Regulation
I hereby claim the benefit und and, insofar as the subject mat application in the manner provide duty to disclose information \$1.56 which occurred between	ler Title 35, United States Co tter of each of the claims of t vided by the first paragraph of on which is material to patent	ode, § 120 of any United Stathis application is not disclose of the Title 35, United States tability as defined in Title 37.	tes application(s) listed belowed in the prior United States Code, § 112, I acknowledge , Code of Federal Regulation
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I hereby claim the benefit und and, insofar as the subject mat application in the manner provide duty to disclose information and the subject materials.	ler Title 35, United States Co tter of each of the claims of t vided by the first paragraph of on which is material to patent en the filing date of the prior	his application is not disclosed the Title 35, United States tability as defined in Title 37 application and the national (Status - pa	tes application(s) listed belowed in the prior United States Code, § 112, I acknowledge, Code of Federal Regulation or PCT international filing
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POWER OF ATTORNEY: I hereby appoint as my attorneys and other attorneys or agents the registered persons identified under

## **CUSTOMER NUMBER** 33942

Cha & Reiter, said attorneys or agents with full power of substitution and for the law firm of: revocation to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

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200 3

Steve S. Cha, Esq.

**CUSTOMER NUMBER** 

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Address all telephone calls to:

(201)518-5518:

I (we) hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor:

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Republic of Korea Same as above

Post office address: Citizenship:

Republic of Korea

Date:

July 11,

Signature:

Residence Address:

Yeong-Seop LEE

Full name of Second inventor:

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Post office address:

Same as above

Citizenship:

Republic of Korea

Date:

Signature: